

| REVISIONS | | | | | | | | | | | | | | | | | | | |
|-----------|--|-----------------|------------|--|--|--|--|--|--|--|--|--|--|--|--|--|--|--|--|
| LTR | DESCRIPTION | DATE (YR-MO-DA) | APPROVED | | | | | | | | | | | | | | | | |
| E | Removed vendor CAGE numbers 18324, 27014, and 34335. Added devices 21 and 22. Updated document format, editorial changes throughout. | 96-06-13 | M. A. Frye | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | |

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| REV | | | | | | | | | | | | | | | | | | | |
| SHEET | | | | | | | | | | | | | | | | | | | |
| REV | E | E | E | E | | | | | | | | | | | | | | | |
| SHEET | 15 | 16 | 17 | 18 | | | | | | | | | | | | | | | |

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|----------------------|-------|---|---|---|---|---|---|---|---|---|----|----|----|----|----|---|---|---|
| REV STATUS OF SHEETS | REV | E | E | E | E | E | E | E | E | E | E | E | E | E | E | E | E | E |
| | SHEET | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | | | |

| | | | | | | | | |
|---|---|--|------------------|---------------------------|-------------------|------------------------|--|--|
| PMIC N/A <div style="text-align: center;"> STANDARD MICROCIRCUIT DRAWING </div> <p style="text-align: center;">THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE</p> <p style="text-align: center;">AMSC N/A</p> | PREPARED BY JAMES JAMISON CHECKED BY CHARLES REUSING APPROVED BY MICHAEL A. FRYE DRAWING APPROVAL DATE 86-06-20 REVISION LEVEL E | <div style="text-align: center;"> DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 </div> <div style="text-align: center; margin-top: 20px;"> MICROCIRCUIT, MEMORY, BIPOLAR, PROGRAMMABLE LOGIC ARRAY, MONOLITHIC SILICON </div> <table border="1" style="width: 100%; border-collapse: collapse; margin-top: 10px;"> <tr> <td style="width: 15%;">SIZE A</td> <td style="width: 35%;">CAGE CODE 67268</td> <td style="width: 50%; text-align: center;">5962-85155</td> </tr> <tr> <td colspan="3">SHEET 1 OF 18</td> </tr> </table> | SIZE A | CAGE CODE 67268 | 5962-85155 | SHEET 1 OF 18 | | |
| SIZE A | CAGE CODE 67268 | 5962-85155 | | | | | | |
| SHEET 1 OF 18 | | | | | | | | |

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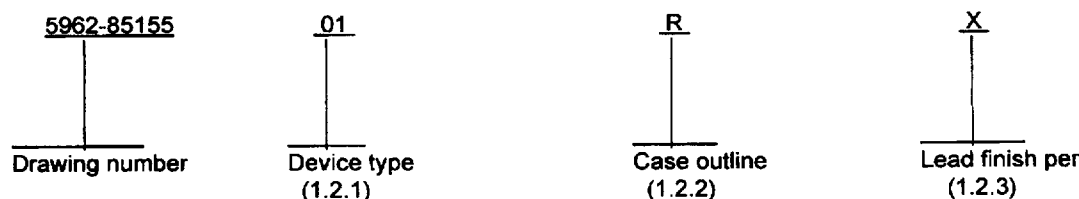
DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

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1. SCOPE

1.1 Scope. This drawing describes device requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A.

1.2 Part or Identifying Number (PIN). The complete PIN shall be as shown in the following example:



1.2.1 Device type(s). The device type(s) shall identify the circuit function as follows:

| Device type | Generic number | Circuit function |
|-------------|----------------|--|
| 01 | PAL16L8-20 | 16-input 8-output AND-OR invert gate array |
| 02 | PAL16R8-20 | 16-input 8-output registered AND-OR gate array |
| 03 | PAL16R6-20 | 16-input 6-output registered AND-OR gate array |
| 04 | PAL16R4-20 | 16-input 4-output registered AND-OR gate array |
| 05 | PAL16L8-30 | 16-input 8-output AND-OR invert gate array |
| 06 | PAL16R8-30 | 16-input 8-output registered AND-OR gate array |
| 07 | PAL16R6-30 | 16-input 6-output registered AND-OR gate array |
| 08 | PAL16R4-30 | 16-input 4-output registered AND-OR gate array |
| 09 | PAL16L8-15 | 16-input 8-output AND-OR invert gate array |
| 10 | PAL16R8-15 | 16-input 8-output registered AND-OR gate array |
| 11 | PAL16R6-15 | 16-input 6-output registered AND-OR gate array |
| 12 | PAL16R4-15 | 16-input 4-output registered AND-OR gate array |
| 13 | PAL16L8A-12 | 16-input 8-output AND-OR invert gate array |
| 14 | PAL16R8A-12 | 16-input 8-output registered AND-OR gate array |
| 15 | PAL16R6-12 | 16-input 6-output registered AND-OR gate array |
| 16 | PAL16R4-12 | 16-input 4-output registered AND-OR gate array |
| 17 | PAL16L8-10 | 16-input 8-output AND-OR invert gate array |
| 18 | PAL16R8-10 | 16-input 8-output registered AND-OR gate array |
| 19 | PAL16R6-10 | 16-input 6-output registered AND-OR gate array |
| 20 | PAL16R4-10 | 16-input 4-output registered AND-OD gate array |
| 21 | PAL16R8-7 | 16-input 8-output registered AND-OR gate array |
| 22 | PAL16R4-7 | 16-input 4-output registered AND-OD gate array |

1.2.2 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

| Outline letter | Descriptive designator | Terminals | Package style |
|----------------|------------------------|-------------|-----------------------------|
| R | GDIP1-T20 | 20-lead | dual-in-line package |
| | CDIP1-T20 | 20-lead | dual-in-line package |
| S | CDFP5-F20 1/ | 20-lead | flat package |
| 2 | CQCC1-N20 | 20-terminal | square chip carrier package |

1/ Inactive for new design. Acceptable only for use in equipment designed or redesigned on or before 29 November 1986.

| | | | |
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1.2.3 Lead finish. The lead finish is as specified in MIL-PRF-38535, appendix A.

1.3 Absolute maximum ratings.

| | |
|---|-----------------------|
| Supply voltage range 2/ ----- | -0.5 V dc to 7.0 V dc |
| Input voltage range 2/ 3/ ----- | -0.5 V dc to 5.5 V dc |
| Storage temperature range ----- | -65°C to +150°C |
| Lead temperature (soldering, 10 seconds) ----- | +260°C |
| Thermal resistance, junction-to-case (Θ_{JC}) 4/ ----- | See MIL-STD-1835 |
| Applied voltage to a disabled output range 2/ 3/ -- | -0.5 V dc to 5.5 V dc |
| Maximum power dissipation (P_D) 5/: | |
| Device types 01, 02, 03, and 04 ----- | 1.1 W |
| Device types 05, 06, 07, and 08 ----- | 0.6 W |
| Device types 09, 10, 11, 12, 13, 14, and 15 thru 20- | 1.2 W |
| Maximum junction temperature (T_J) ----- | +175°C |

1.4 Recommended operating conditions.

| | |
|--|--------------------------------------|
| Supply voltage range (V_{CC}) ----- | 4.5 V dc minimum to 5.5 V dc maximum |
| Minimum high level input voltage (V_{IH}) ----- | 2.0 V dc |
| Maximum low level input voltage (V_{IL}) ----- | 0.8 V dc |
| Maximum high level output current (I_{OH}) ----- | -2.0 mA dc |
| Maximum low level output current (I_{OL}) ----- | 12.0 mA dc |
| Case operating temperature range ----- | -55°C to +125°C |

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation.

SPECIFICATION

MILITARY

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.
MIL-STD-973 - Configuration Management.
MIL-STD-1835 - Microcircuit Case Outlines.

- 2/ These ratings apply except for programming pins during a programming cycle.
3/ To ensure high speed operation, input logic levels must be maintained within these conditions.
4/ Heat sinking is recommended to reduce the junction temperature.
5/ Must withstand the added P_D due to short-circuit test; e.g., I_{OS} .

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HANDBOOKS

MILITARY

MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein. Product built to this drawing that is produced by a Qualified Manufacturer Listing (QML) certified and qualified manufacturer or a manufacturer who has been granted transitional certification to MIL-PRF-38535 may be processed as QML product in accordance with the manufacturers approved program plan and qualifying activity approval in accordance with MIL-PRF-38535. This QML flow as documented in the Quality Management (QM) plan may make modifications to the requirements herein. These modifications shall not affect form, fit, or function of the device. These modifications shall not affect the PIN as described herein. A "Q" or "QML" certification mark in accordance with MIL-PRF-38535 is required to identify when the QML flow option is used.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535, appendix A and herein.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Truth table.

3.2.3.1 Unprogrammed devices. The truth table for unprogrammed devices for contracts involving no altered item drawing shall be as specified on figure 2. When required in groups A, B, or C (see 4.3.1c), the devices shall be programmed by the manufacturer prior to test. A minimum of 50 percent of the total number of fuses shall be programmed) or to any altered item drawing pattern which programs at least 25 percent of the total number of fuses programmed.

3.2.3.2 Programmed devices. The truth table for programmed devices shall be as specified by an attached altered item drawing.

3.2.4 Switching waveforms and test circuit. The switching waveforms and test circuit shall be as specified on figure 4.

3.3 Electrical performance characteristics. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and shall apply over the full (case or ambient) operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.

3.5 Marking. Marking shall be in accordance with MIL-PRF-38535, appendix A. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103 (see 6.6 herein). For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device.

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3.6 Processing options. Since the device is capable of being programmed by either the manufacturer or the user to result in a wide variety of configurations, two processing options are provided for selection in the contract, using an altered item drawing.

3.6.1 Unprogrammed device delivered to the user. All testing shall be verified through group A testing as defined in 3.2.3.1 and table II. It is recommended that users perform subgroups 7 and 9 after programming to verify the specific program configuration.

3.6.2 Manufacturer-programmed device delivered to the user. All testing requirements and quality assurance provisions herein, including the requirements of the altered item drawing shall be satisfied by the manufacturer prior to delivery.

3.7 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6 herein). The certificate of compliance submitted to DESC-EC prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-PRF-38535, appendix A and the requirements herein.

3.8 Certificate of conformance. A certificate of conformance as required in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.9 Notification of change. Notification of change to DESC-EC shall be required in accordance with MIL-PRF-38535, appendix A.

3.10 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.8 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.9 Notification of change. Notification of change to DESC-EC shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.10 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.7 herein).

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

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TABLE 1. Electrical performance characteristics.

| Test | Symbol | Conditions $4.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$ $-55^{\circ}\text{C} \leq T_C \leq +125^{\circ}\text{C}$ unless otherwise specified | Group A Subgroups | Device type | Limits | | Unit |
|------------------------------------|----------|--|----------------------|--------------------------|--------|-------|---------------|
| | | | | | Min | Max | |
| Input clamp voltage | V_{IC} | $V_{CC} = 4.5\text{ V}, I_I = -18\text{ mA}$ | 1, 2, 3 | All | | -1.5 | V |
| High Level output voltage | V_{OH} | $V_{CC} = 4.5\text{ V}, V_{IL} = 4.5\text{ V},$ $V_{IH} = 2.0\text{ V}, I_{OH} = -2\text{ mA}$ | 1, 2, 3 | 01,02, 04-20 | 2.4 | | V |
| | | | | 03,21, 22 | 2.3 | | |
| Low level output voltage | V_{OL} | $V_{CC} = 4.5\text{ V}, V_{IL} = 4.5\text{ V},$ $V_{IH} = 2.0\text{ V}, I_{OL} = 12\text{ mA}$ | 1, 2, 3 | All | | 0.5 | V |
| High level input voltage | V_{IH} | | 1, 2, 3 | All | 2 | | V |
| Low level input voltage | V_{IL} | | 1, 2, 3 | All | | 0.8 | V |
| High level input current | I_{IH} | $V_{CC} = 5.5\text{ V},$ $V_I = 2.4\text{ V}$ | 1, 2, 3 | Pins CLK and OE | | 50 | μA |
| | | | | All others except I/O | | 25 | |
| | | | | All I/O ports | | 100 | |
| Low level input current | I_{II} | $V_{CC} = 5.5\text{ V}, V_{II} = 0.4\text{ V}$ | 1, 2, 3 | All | | -0.25 | mA |
| Input current | I_I | $V_{CC} = 5.5\text{ V}, V_I = 5.5\text{ V}$ | 1, 2, 3 | All | | 1 | mA |
| Output current short circuit 1/ | I_{OS} | $V_{CC} = 5.5\text{ V}, V_O = 0.5\text{ V}$ | 1, 2, 3 | 01-16 | -30 | -250 | mA |
| | | | | 17-22 | -30 | -130 | |

See footnotes at end table.

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TABLE I. Electrical performance characteristics.

| Test | Symbol | Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V -55°C ≤ T _C ≤ +125°C unless otherwise specified | | Group A Subgroups | Device type | Limits | | Unit |
|---|-------------------|--|----------------------|----------------------|----------------|--------|--------------|------|
| | | | | | | Min | Max | |
| Off-state output current | I _{OZL} | V _{CC} = 5.5 V, V _I = 0.4 V | Outputs I/O ports | 1, 2, 3 | All | | -100 -250 | μA |
| Off-state output current | I _{OZH} | V _{CC} = 5.5 V, V _O = 2.4 V | | 1, 2, 3 | All | | 100 | μA |
| Supply current | I _{CC} | V _{CC} = 5.5 V, V _I = 0 V Outputs open | | 1, 2, 3 | 01-04 | | 190 | mA |
| | | | | | 05-08 | | 105 | |
| | | | | | 09-20 | | 220 | |
| | | | | | 21,22 | | 210 | |
| Propagation delay data input to output | t _{PLH1} | See figure 3 | | 9, 10, 11 | 01,03,04 | | 20 | ns |
| | | | | | 05,07,08 | | 30 | |
| | | | | | 09,11,12 | | 15 | |
| | | | | | 13,15,16 | | 12 | |
| | | | | | 17,19,20 | | 10 | |
| | | | | | 21,22 | | 7 | |
| Propagation delay data input to output | t _{PHL1} | | | | 01,03,04 | | 20 | |
| | | | | | 05,07,08 | | 30 | |
| | | | | | 09,11,12 | | 15 | |
| | | | | | 13,15,16 | | 12 | |
| | | | | | 17,19,20 | | 10 | |
| | | | | | 21,22 | | 7 | |
| Propagation delay clock/up to output | t _{PHL2} | 02 - 04 | | 15 | | | | |
| | | 06 - 08 | | 20 | | | | |
| | | 10 - 12, 14,16 | | 12 | | | | |
| | | 18, 20 | | 10 | | | | |
| | | 21, 22 | | 7 | | | | |

See footnotes at end of table.

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TABLE I. Electrical performance characteristics.

| Test | Symbol | Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V -55°C ≤ T _C ≤ +125°C unless otherwise specified | Group A Subgroups | Device type | Limits | | Unit | | |
|--|-------------------|--|----------------------|---|-------------------|----------|------|--|----|
| | | | | | Min | Max | | | |
| Propagation delay clock/up to output | t _{PLH2} | See figure 3 | 9, 10, 11 | 02 - 04 | | 15 | ns | | |
| | | | | 06 - 08 | | 20 | | | |
| | | | | 10 - 12, 14,16 | | 12 | | | |
| | | | | 18 - 20 | | 10 | | | |
| | | | | 21, 22 | | 7 | | | |
| Propagation delay output high impedance to output high | t _{PZH1} | | | 01,03,04 | | 25 | | | |
| | | | | 05,07,08 | | 30 | | | |
| | | | | 09,11,12 | | 17 | | | |
| | | | | 13,15,16 | | 14 | | | |
| | | | | 17,19,20 | | 12 | | | |
| | | | | 21,22 | | 9 | | | |
| | | | | Propagation delay output high impedance to output low | t _{PZL1} | 01,03,04 | | | 25 |
| | | | | | | 05,07,08 | | | 30 |
| 09,11,12 | | | | | | 17 | | | |
| 13,15,16 | | | | | | 14 | | | |
| 17,19,20 | | | | | | 12 | | | |
| 21,22 | | | | | | 9 | | | |
| Propagation delay output high to output high impedance 2/ | t _{PHZ1} | | | | | 01,03,04 | | | 20 |
| | | | | | | 05,07,08 | | | 30 |
| | | | | 09,11,12 | | 15 | | | |
| | | | | 13,15,16 | | 12 | | | |
| | | | | 17,19, 20,21, 22 | | 10 | | | |

See footnotes at end of table.

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| STANDARD MICROCIRCUIT DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 | SIZE A | | 5962-85155 |
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TABLE I. Electrical performance characteristics.

| Test | Symbol | Conditions 4.5 V ≤ V _{CC} ≤ 5.5 V -55°C ≤ T _C ≤ +125°C unless otherwise specified | Group A Subgroups | Device type | Limits | | Unit |
|--|-------------------|--|----------------------|----------------------|--------|-----|------|
| | | | | | Min | Max | |
| Propagation delay output low to output high impedance 2/ | t _{PLZ1} | See figure 4 | 9, 10, 11 | 01,03,04 | | 20 | ns |
| | | | | 05,07,08 | | 30 | |
| | | | | 09,11,12 | | 15 | |
| | | | | 13,15,16 | | 12 | |
| | | | | 17,19, 20,21,22 | | 10 | |
| Propagation delay high impedance to output high (OE to output enable) 3/ | t _{PZH2} | | | 01,03,04 | | 20 | |
| | | | | 05,07,08 | | 30 | |
| | | | | 09,11,12 | | 15 | |
| | | | | 13,15,16 | | 12 | |
| | | | | 17,19,20 | | 10 | |
| | | | | 21,22 | | 8 | |
| | | | | 02,03,04 | | 20 | |
| Propagation delay hgih impedance to output low (OE to output enable 3/ | t _{PZL2} | | | 06,07,08 | | 25 | |
| | | | | 10,11,12, 14 - 16 | | 12 | |
| | | | | 18 - 20 | | 10 | |
| | | | | 21,22 | | 8 | |
| | | | | 02,03,04 | | 20 | |
| Propagation delay output high to high impedance (OE to output disable 2/ 3/ | t _{PHZ2} | | | 06,07,08 | | 25 | |
| | | | | 10,11,12, 14 - 16 | | 12 | |
| | | | | 18 - 20, 21,22 | | 10 | |

See footnotes at end of table.

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TABLE I. Electrical performance characteristics.

| Test | Symbol | Conditions $4.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$ $-55^{\circ}\text{C} \leq T_C \leq +125^{\circ}\text{C}$ unless otherwise specified | Group A Subgroups | Device Type | Limits | | Unit |
|--|------------|--|----------------------|----------------------|--------|-----|------|
| | | | | | Min | Max | |
| Propagation delay output low to high impedance (OE to output disable <u>2/ 3/</u> | t_{PLZ2} | See figure 3 | 9, 10, 11 | 02,03,04 | | 20 | ns |
| | | | | 06,07,08 | | 25 | |
| | | | | 10,11,12, 14 - 16 | | 12 | |
| | | | | 18 - 20, 21,22 | | 10 | |
| Clock pulse width, high <u>4/</u> | t_{PCLH} | | | 02,03,04 | 12 | | |
| | | | | 06,07,08 | 20 | | |
| | | | | 10,11,12, 14 - 16 | 9 | | |
| | | | | 18 - 20 | 8 | | |
| | | | | 21,22 | 5 | | |
| Clock pulse width, low <u>4/</u> | t_{PCLL} | | | 02 - 04, 10 - 12 | 12 | | |
| | | | | 06,07,08 | 20 | | |
| | | | | 14 - 16 | 9 | | |
| | | 18 - 20 | 8 | | | | |
| | | 21,22 | 5 | | | | |

See footnotes at end of table.

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TABLE I. Electrical performance characteristics.

| Test | Symbol | Conditions $4.5\text{ V} \leq V_{CC} \leq 5.5\text{ V}$ $-55^{\circ}\text{C} \leq T_C \leq +125^{\circ}\text{C}$ unless otherwise specified | Group A Subgroups | Device type | Limits | | Unit |
|--|-----------|--|----------------------|---|--------|-----|------|
| | | | | | Min | Max | |
| Hold time | t_H | See figure 4 | 9, 10, 11 | 02,03,04, 06,07,08, 10,11,12, 14,15,16, 18,20,21, 22 | 0 | | ns |
| Setup time | t_{SU} | | | 02,03,04 | 20 | | |
| | | | | 06,07,08 | 30 | | |
| | | | | 10,11,12 | 15 | | |
| | | | | 14 - 16, 18 - 20 | 11 | | |
| | | | | 21,22 | 7 | | |
| Maximum clock frequency data path register | f_{MAX} | 02,03,04 | | 41.6 | | MHz | |
| | | 06,07,08 | | 25.0 | | | |
| | | 10,11,12 | | 50.0 | | | |
| | | 14 - 16 | | 56.0 | | | |
| | | 18 - 20 | | 62.5 | | | |
| | | 21,22 | 100 | | | | |

- 1/ The output conditions may be chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS} .
- 2/ Testing shall be performed using $C_L = 5\text{ pF}$.
- 3/ Test applies only to register outputs.
- 4/ The total clock period of CLK high and CLK low must not exceed clock frequency, f_{clock} . Minimum pulse durations specified are only for CLK high or CLK low, but not for both simultaneously.

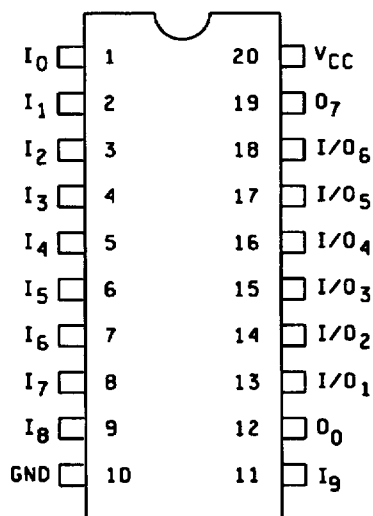
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| STANDARD MICROCIRCUIT DRAWING DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444 | SIZE A | | 5962-85155 |
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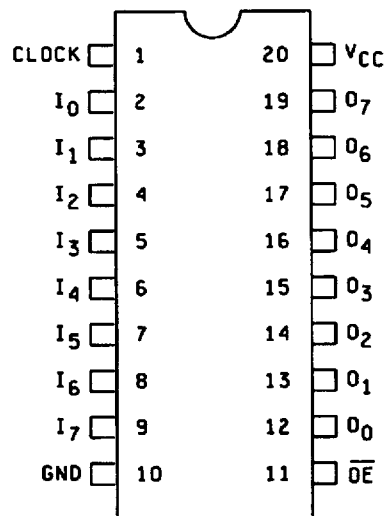
DEVICE TYPES 01,05,09,13, AND 17

CASE R AND S



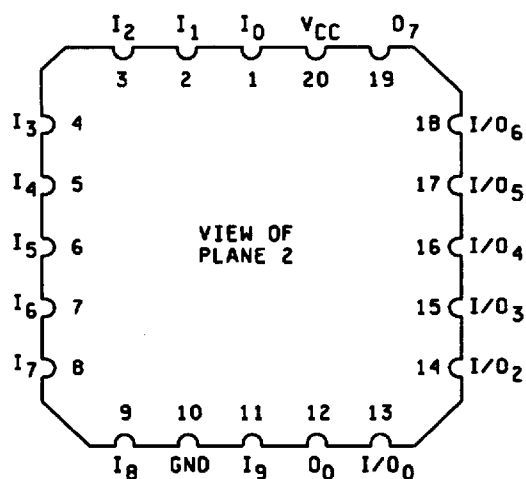
DEVICE TYPES 02,06,10,14,18, AND 21

CASE R AND S



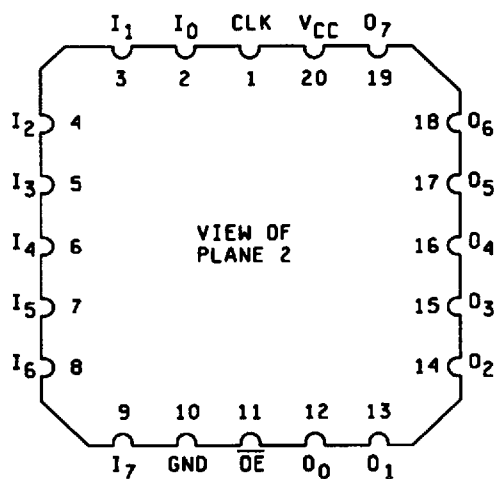
DEVICE TYPES 01,05,09,13, AND 17

CASE 2



DEVICE TYPES 02,06,10,14,18, AND 21

CASE 2



Option A with active terminals
on plane 1.

Option A with active terminals
on plane 1.

FIGURE 1. Terminal connections.

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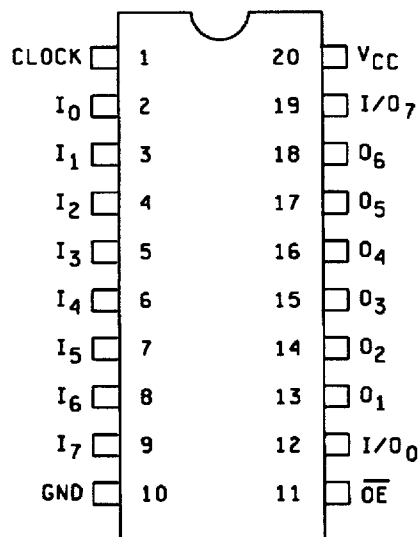
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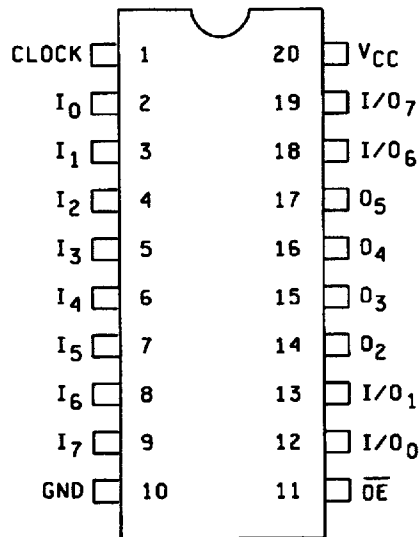
DEVICE TYPES 03,07,11,15, AND 19

CASE R AND S



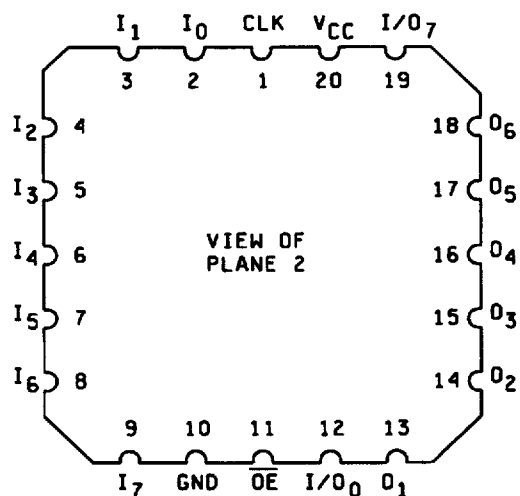
DEVICE TYPES 04,08,12,16,20, AND 22

CASE R AND S



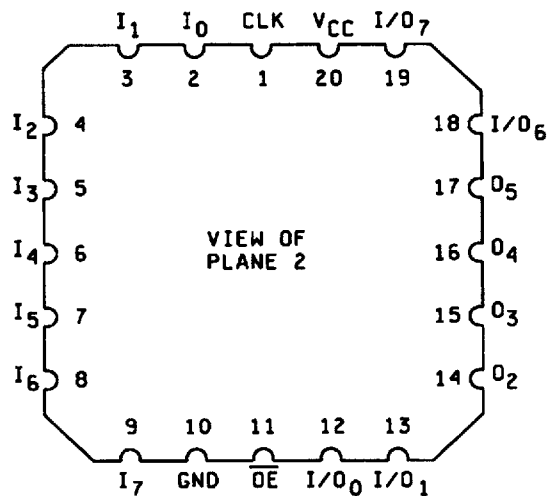
DEVICE TYPES 03,07,11,15, AND 19

CASE 2



DEVICE TYPES 04,08,12,16,20, AND 22

CASE 2



Option A with active terminals
on plane 1.

Option A with active terminals
on plane 1.

FIGURE 1. Terminal connections - Continued.

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Device types 01 through 22

| Truth table | | | | | | | | | | | | | | | | | | | | |
|-------------|----|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|---------------------------|
| Address | | | | | | | | | | | | Output level | | | | | | | | Device |
| CK | OE | I ₉ | I ₈ | I ₇ | I ₆ | I ₅ | I ₄ | I ₃ | I ₂ | I ₁ | I ₀ | O ₇ | O ₆ | O ₅ | O ₄ | O ₃ | O ₂ | O ₁ | O ₀ | |
| | | X | X | X | X | X | X | X | X | X | X | Z | Z | Z | Z | Z | Z | Z | Z | 01,05, 09,13, 17 |
| CK | L | | | X | X | X | X | X | X | X | X | H | H | H | H | H | H | H | H | 02,06, 10,14, 18,21 |
| CK | L | | | X | X | X | X | X | X | X | X | Z | H | H | H | H | H | H | Z | 03,07, 11,15, 19 |
| CK | L | | | X | X | X | X | X | X | X | X | Z | Z | H | H | H | H | Z | Z | 04,08, 12,16, 20,22 |

NOTES:

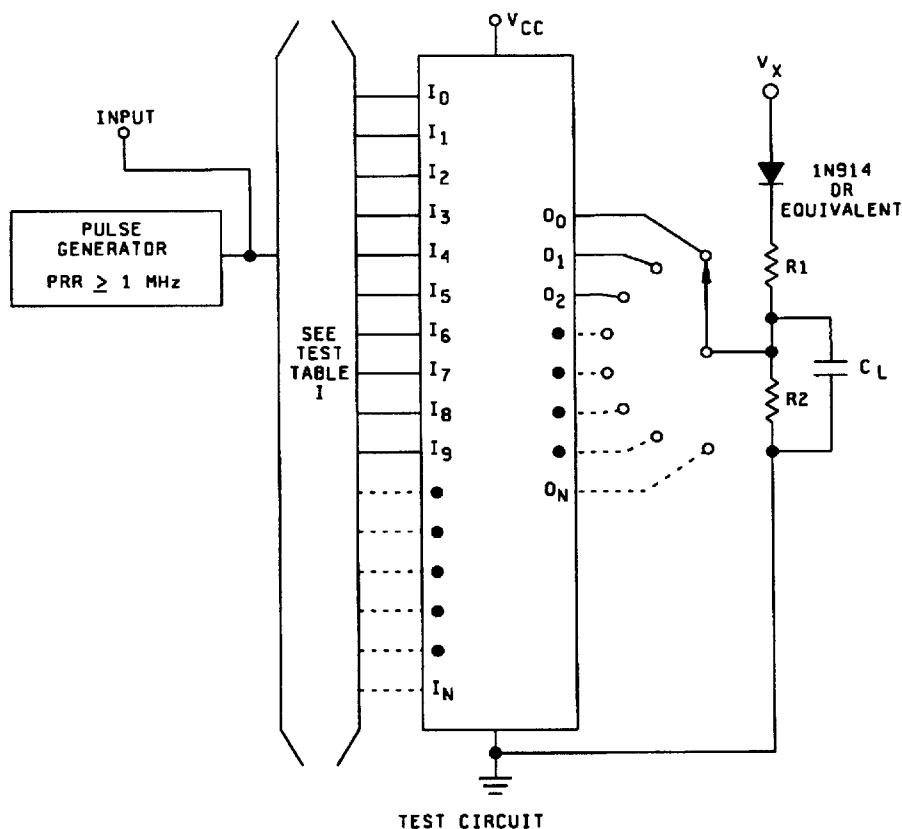
1. Z = three-state.
2. Clock (pin 1): Low to high transition required to obtain valid data after last address transition.
3. Enable (pin 11): Must be low to enable output.

FIGURE 2. Truth table (unprogrammed).

| | | | |
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NOTES:

1. $C_L = 50$ pF minimum, including jig and probe capacitance; $R_1 = 365\Omega \pm 2\%$; $R_2 = 715\Omega \pm 2\%$.
2. The tests shall check all inputs, gates, and outputs that have been programmed. The test shall be performed $V_{CC} = 4.5$ V and 5.5 V.
3. $V_X = 5.7$ V for t_{PLH} , t_{PHL} , t_{PZL} , and t_{PLZ} tests and 0 V for t_{PHZ} , t_{PZH} and f_{max} tests.

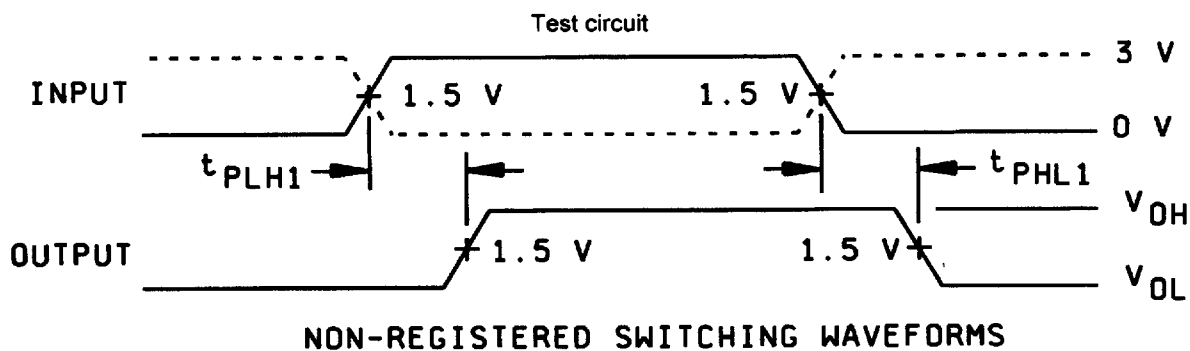
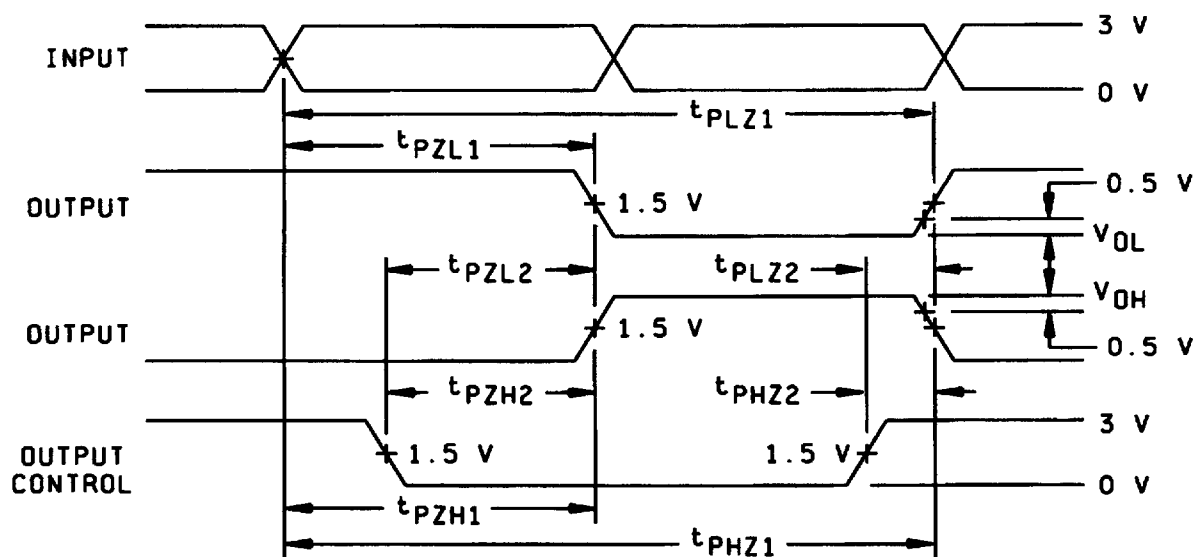
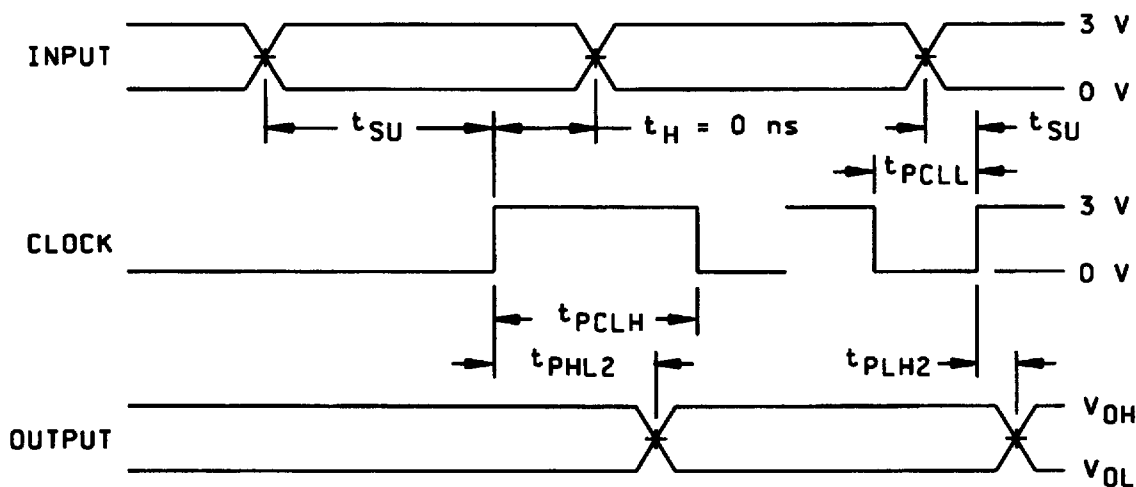


FIGURE 3. Test circuit and switching waveforms.

| | | | |
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INPUT AND OUTPUT CONTROL SWITCHING WAVEFORM



REGISTERED SWITCHING WAVEFORM

FIGURE 3. Test circuit and switching waveforms - Continued.

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4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 4, 5, and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Unprogrammed devices shall be tested for programmability and ac performance compliance to the requirements of group A, subgroups 9, 10, and 11. Either of the two following techniques is acceptable:
 - (1) Testing the entire lot using additional built-in test circuitry which allows the manufacturer to verify programmability and ac performance without programming the user array. If this is done, the resulting test patterns shall be verified on all devices during subgroups 9, 10, and 11, group A testing in accordance with the sampling plan specified in method 5005 of MIL-STD-883.
 - (2) If such compliance cannot be tested on an unprogrammed device, a sample shall be selected to satisfy programmability requirements prior to performing subgroups 9, 10, and 11. Twelve devices shall be submitted to programming (see 3.2.3.1). If more than two devices fail to program, the lot shall be rejected. At the manufacturer's option, the sample may be increased to 24 total devices with no more than 4 total device failures allowable. Ten devices from the programmability sample shall be submitted to the requirements of group A, subgroups 9, 10, and 11. If more than two total devices fail, the lot shall be rejected. At the manufacturers option, the sample may be increased to 20 total devices with no more than 4 total device failures allowable.

4.3.2 Groups C and D inspections.

- a. End-point electrical parameters shall be as specified in table II herein.
- b. Steady-state life test conditions, method 1005 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.7 herein).
 - (2) $T_A = +125^{\circ}\text{C}$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.4 Programming procedures. The programming procedures shall be as specified by the device manufacturer.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535, appendix A.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

| | | | |
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TABLE II. Electrical test requirements. *

| MIL-STD-883 test requirements | Subgroups (per method 5005, table I) |
|---|--|
| Interim electrical parameters (method 5004) | 1 |
| Final electrical test parameters (method 5004) for unprogrammed devices | 1**, 2, 3, 7**, 8 |
| Final electrical test parameters (method 5004) for programmed devices | 1**, 2, 3, 7**, 8, 9 |
| Group A test requirements (method 5005) | 1, 2, 3, 7, 8, 9, 10***, 11*** |
| Groups C and D end-point electrical parameters (method 5005) | 1, 2, 3, 7, 8 |

* Indicates any or all subgroups may be combined when using high-speed testers. Subgroups 7 and 8 functional tests shall verify the truth table of figure 2, for unprogrammed devices or that the altered item drawing pattern exists for programmed devices.

** Indicates PDA applies to subgroups 1 and 7.

*** Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

6.3 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.

6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-EC, telephone (513) 296-6047.

6.5 Comments. Comments on this drawing should be directed to DESC-EC, Dayton, Ohio 45444-5270, or telephone (513) 296-5377.

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-EC.

| | | | |
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